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ON Semiconductor®

N-Channel MOSFET

200 V, 9 A, 400 mΩ

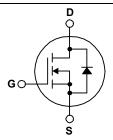
Description

These N-Channel enhancement mode power field effect transistors are produced using ON Semiconductors proprietary, planar, DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switching DC/DC converters, switch mode power supplies, DC-AC converters for uninterrupted power supply and motor control.

Features

- 9.0 A, 200 V, $R_{DS(on)}$ = 400 m Ω (Max.) @ V_{GS} = 10 V, I_{D} = 4.5 A
- Low Gate Charge (Typ. 22 nC)
- Low C_{rss} (Typ. 22 pF)
- 100% Avalanche Tested





Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol	Parameter		IRFW630BTM_FP001	Unit
V _{DSS}	Drain-Source Voltage		200	V
I _D	Drain Current - Continuous (T _C = 25°C)		9.0	Α
	- Continuous (T _C = 100°C)		5.7	Α
I _{DM}	Drain Current - Pulsed	(Note 1)	36	Α
V _{GSS}	Gate-Source voltage		± 30	V
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		160	mJ
I _{AR}	Avalanche Current (Note 1)		9.0	Α
E _{AR}	Repetitive Avalanche Energy (Note 1)		7.2	mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)		5.5	V/ns
P_D	Power Dissipation (T _A = 25°C)*		3.13	W
	Power Dissipation (T _C = 25°C)		72	W
	- Derate above 25°C		0.57	W/°C
T _{J,} T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C
TL	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds		300	°C

Thermal Characteristics

Symbol	Parameter	IRFW630BTM_FP001	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	1.74	
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Min. Pad of 2-oz Copper), Max.	62.5	°C/W
	Thermal Resistance, Junction to Ambient (*1 in² Pad of 2-oz Copper), Max.	40	

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
IRFW630B	IRFW630BTM-FP001	D ² -PAK	330 mm	24 mm	800 units

Electrical Characteristics $T_C = 25^{\circ}C$ unless otherwise noted.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Off Charac	teristics					
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0 V, I _D = 250 μA	200			V
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient	I _D = 250 μA, Referenced to 25°C		0.2		V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 200 V, V _{GS} = 0 V			10	μΑ
		V _{DS} = 160 V, T _C = 125°C			100	μА
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = 30 V, V _{DS} = 0 V			100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V _{GS} = -30 V, V _{DS} = 0 V			-100	nA
On Charac	teristics					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.0		4.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = 10 V, I _D = 4.5 A		0.34	0.4	Ω
9 _{FS}	Forward Transconductance	V _{DS} = 40 V, I _D = 4.5 A		7.05		S
Dynamic C	Characteristics					
C _{iss}	Input Capacitance	V _{DS} = 25 V, V _{GS} = 0 V,		550	720	pF
C _{oss}	Output Capacitance	f = 1.0 MHz		85	110	pF
C _{rss}	Reverse Transfer Capacitance			22	29	pF
Switching	Characteristics					,
t _{d(on)}	Turn-On Delay Time	V_{DD} = 100 V, I_{D} = 9.0 A R_{G} = 25 Ω (Note 4)		11	30	ns
t _r	Turn-On Rise Time			70	150	ns
t _{d(off)}	Turn-Off Delay Time			60	130	ns
t _f	Turn-Off Fall Time			65	140	ns
Q _g	Total Gate Charge	V _{DS} = 160 V, I _D = 9.0 A V _{GS} = 10 V		22	29	nC
Q _{gs}	Gate-Source Charge			3.6		nC
Q _{gd}	Gate-Drain Charge	(Note 4)		10.2		nC
Drain-Sour	rce Diode Characteristics and Maximu	m Ratings				,
I _S	Maximum Continuous Drain-Source Diode Forward Current				9.0	Α
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current				36	Α
V_{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0 V, I _S = 9.0 A			1.5	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0 V, I _S = 9.0 A		140		ns
Q _{rr}	Reverse Recovery Charge	dI _F /dt =100 A/μs		0.87		μС

Notes

^{1.} Repetitive rating: pulse-width limited by maximum junction temperature.

^{2.} L = 3 mH, I_{AS} = 9.0 A, V_{DD} = 50 V, R_G = 25 Ω , starting T_J = 25°C.

 $^{3.~}I_{SD} \leq 9.0~A,~di/dt \leq 300~A/\mu s,~V_{DD} \leq BV_{DSS,}~starting~~T_J = 25^{\circ}C.$

^{4.} Essentially independent of operating temperature.

Typical Characteristics

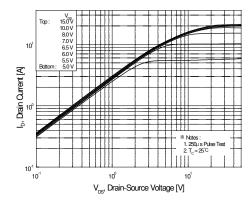


Figure 1. On-Region Characteristics

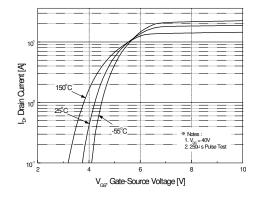


Figure 2. Transfer Characteristics

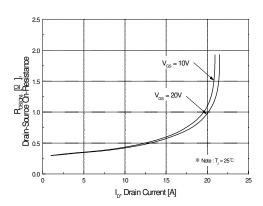


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

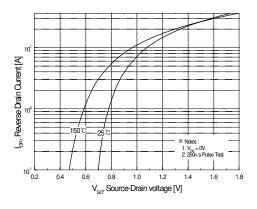


Figure 4. Body Diode Forward Voltage Variation with Source Current and Temperature

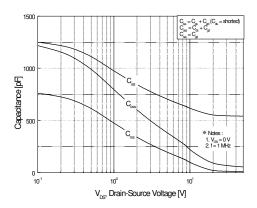


Figure 5. Capacitance Characteristics

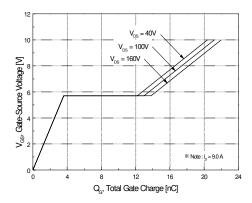


Figure 6. Gate Charge Characteristics

Typical Characteristics (Continued)

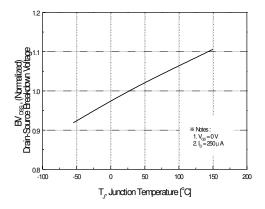
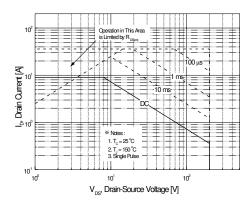


Figure 7. Breakdown Voltage Variation vs. Temperature

Figure 8. On-Resistance Variation vs. Temperature



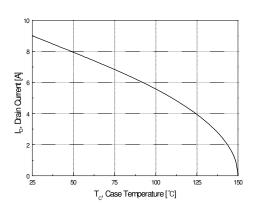


Figure 9. Maximum Safe Operating Area

Figure 10. Maximum Drain Current vs. Case Temperature

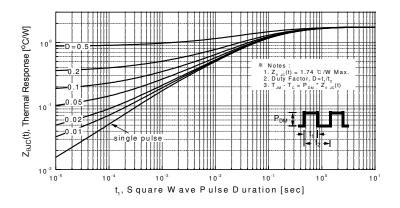


Figure 11. Transient Thermal Response Curve

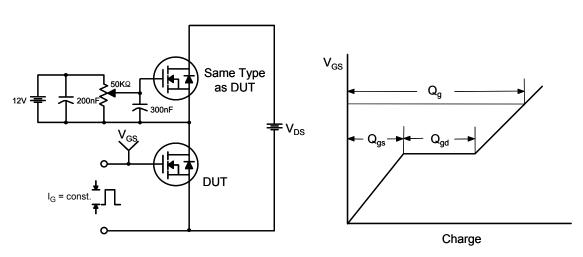


Figure 12. Gate Charge Test Circuit & Waveform

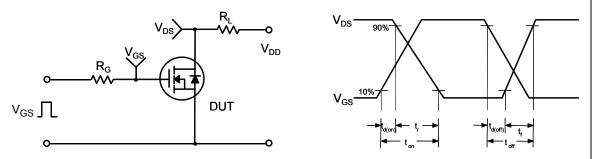


Figure 13. Resistive Switching Test Circuit & Waveforms

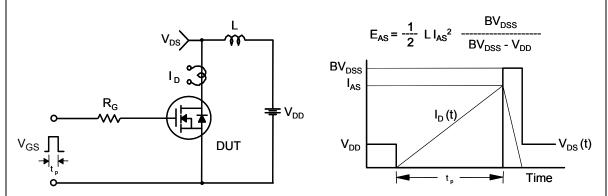
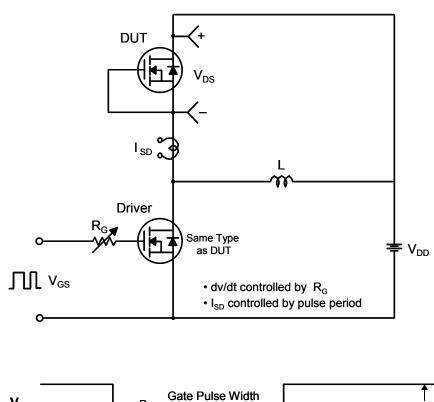


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms



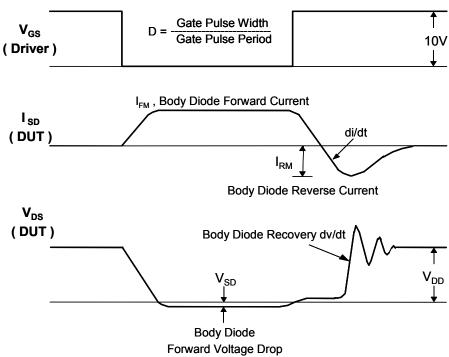


Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms

Mechanical Dimensions

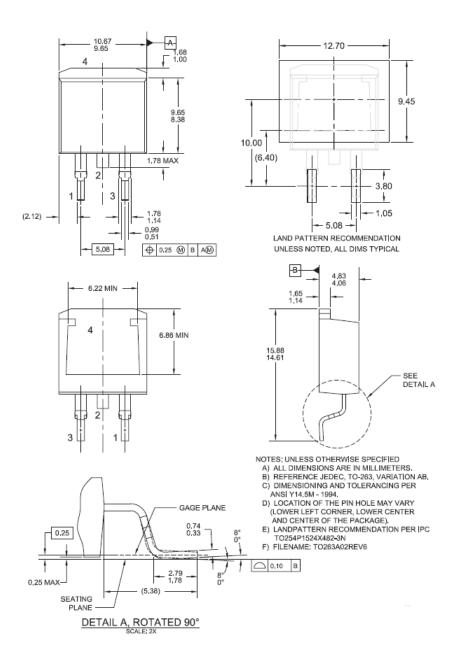


Figure 16. TO263 (D²PAK), Molded, 2-Lead, Surface Mount

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